

MC33PF8200CLES

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For Reference Only

Part Number MC33PF8200CLES

Manufacturer NXP

Category Integrated Circuits (ICs)

PMIC - Power Management - Specialized

DescriptionIC POWER MANAGEMENTPackage56-VFQFN Exposed Pad

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









MC33PF8200CLES Specifications

Manufacturer Part Number	MC33PF8200CLES
Manufacturer	NXP
Category	Integrated Circuits (ICs)
	PMIC - Power Management - Specialized
Package	56-VFQFN Exposed Pad
Series	-
Applications	High Performance i.MX 8, S32x Processor Based
Current - Supply	-
Voltage - Supply	2.5V ~ 5.5V
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount, Wettable Flank
Package / Case	56-VFQFN Exposed Pad
Supplier Device Package	56-HVQFN (8x8)
	Report errors?

MC33PF8200CLES Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MC33PF8200CLES Payment Methods



















MC33PF8200CLES Shipping Methods













If you have any question about MC33PF8200CLES, please do not hesitate to contact us!

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